

# IGBT - Field Stop II NGTB40N65FL2WG

This Insulated Gate Bipolar Transistor (IGBT) features a robust and cost effective Field Stop II Trench construction, and provides superior performance in demanding switching applications, offering both low on state voltage and minimal switching loss. The IGBT is well suited for UPS and solar applications. Incorporated into the device is a soft and fast co–packaged free wheeling diode with a low forward voltage.

#### **Features**

- Extremely Efficient Trench with Field Stop Technology
- $T_{Jmax} = 175^{\circ}C$
- Soft Fast Reverse Recovery Diode
- Optimized for High Speed Switching
- 5 µs Short-Circuit Capability
- These are Pb-Free Devices

### **Typical Applications**

- Solar Inverters
- Uninterruptible Power Supplies (UPS)
- Welding

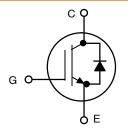
#### **ABSOLUTE MAXIMUM RATINGS**

Rating	Symbol	Value	Unit
Collector-emitter Voltage	V <sub>CES</sub>	650	V
Collector Current @ T <sub>C</sub> = 25°C @ T <sub>C</sub> = 100°C	I <sub>C</sub>	80 40	A
Diode Forward Current @ T <sub>C</sub> = 25°C @ T <sub>C</sub> = 100°C	I <sub>F</sub>	80 40	А
Diode Pulsed Current T <sub>PULSE</sub> Limited by T <sub>J</sub> Max	I <sub>FM</sub>	160	Α
Pulsed Collector Current, T <sub>pulse</sub> Limited by T <sub>Jmax</sub>	I <sub>CM</sub>	160	Α
Short-circuit Withstand Time $V_{GE}$ = 15 V, $V_{CE}$ = 400 V, $T_{J} \le +150^{\circ}C$	t <sub>SC</sub>	5	μS
Gate-emitter Voltage	$V_{GE}$	±20	V
Transient Gate-emitter Voltage (T <sub>PULSE</sub> = 5 μs, D < 0.10)		±30	<b>V</b>
Power Dissipation @ T <sub>C</sub> = 25°C @ T <sub>C</sub> = 100°C	P <sub>D</sub>	366 183	W
Operating Junction Temperature Range	TJ	–55 to +175	°C
Storage Temperature Range	T <sub>stg</sub>	-55 to +175	°C
Lead temperature for soldering, 1/8" from case for 5 seconds	T <sub>SLD</sub>	260	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1

40 A, 650 V V<sub>CEsat</sub> = 1.7 V E<sub>off</sub> = 0.44 mJ





#### MARKING DIAGRAM



40N65FL2 = Specific Device Code

A = Assembly Location Y = Year WW = Work Week G = Pb-Free Package

#### **ORDERING INFORMATION**

Device	Package	Shipping
NGTB40N65FL2WG	TO-247 (Pb-Free)	30 Units / Rail

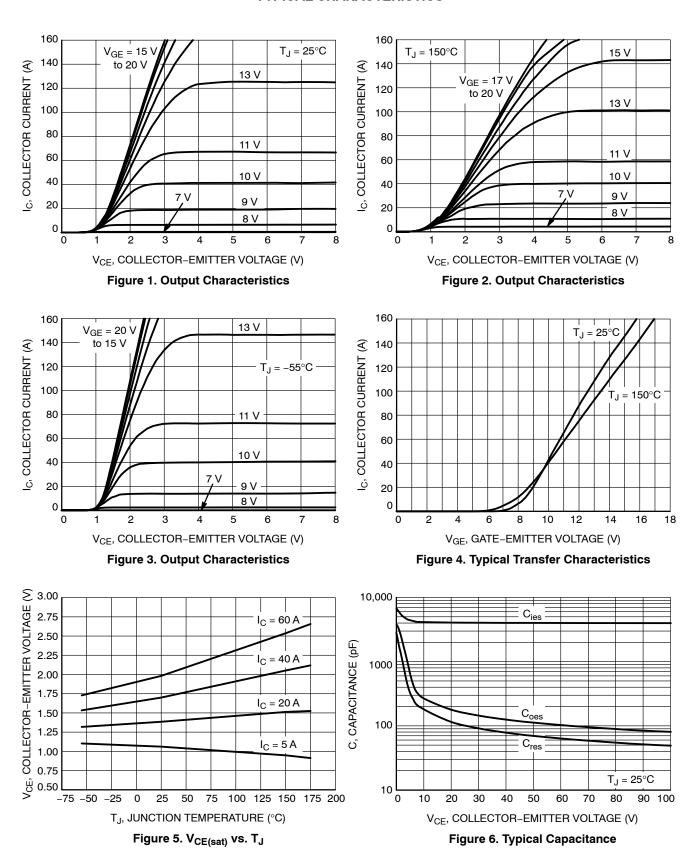
#### THERMAL CHARACTERISTICS

Rating	Symbol	Value	Unit
Thermal resistance junction-to-case, for IGBT	$R_{ heta JC}$	0.41	°C/W
Thermal resistance junction-to-case, for Diode	$R_{ heta JC}$	1.00	°C/W
Thermal resistance junction-to-ambient	$R_{ heta JA}$	40	°C/W

### **ELECTRICAL CHARACTERISTICS** ( $T_J = 25^{\circ}C$ unless otherwise specified)

Parameter	Test Conditions	Symbol	Min	Тур	Max	Unit
STATIC CHARACTERISTIC						
Collector-emitter breakdown voltage, gate-emitter short-circuited	$V_{GE} = 0 \text{ V, I}_{C} = 500 \mu\text{A}$	V <sub>(BR)CES</sub>	650	_	-	V
Collector-emitter saturation voltage	V <sub>GE</sub> = 15 V, I <sub>C</sub> = 40 A V <sub>GE</sub> = 15 V, I <sub>C</sub> = 40 A, T <sub>J</sub> = 175°C	V <sub>CEsat</sub>	1.50 -	1.70 2.10	2.00	V
Gate-emitter threshold voltage	$V_{GE} = V_{CE}, I_{C} = 350 \mu A$	V <sub>GE(th)</sub>	4.5	5.5	6.5	V
Collector-emitter cut-off current, gate- emitter short-circuited	$V_{GE} = 0 \text{ V}, V_{CE} = 650 \text{ V}$ $V_{GE} = 0 \text{ V}, V_{CE} = 650 \text{ V}, T_{J=175^{\circ}\text{C}}$	I <sub>CES</sub>	- -	- -	0.5 7.0	mA
Gate leakage current, collector-emitter short-circuited	V <sub>GE</sub> = 20 V , V <sub>CE</sub> = 0 V	I <sub>GES</sub>	-	_	200	nA
DYNAMIC CHARACTERISTIC	•			•		•
Input capacitance		C <sub>ies</sub>	-	4060	_	pF
Output capacitance	V <sub>CE</sub> = 20 V, V <sub>GE</sub> = 0 V, f = 1 MHz	C <sub>oes</sub>	_	179	-	
Reverse transfer capacitance	1	C <sub>res</sub>	_	115	-	
Gate charge total		Qg	-	170	-	nC
Gate to emitter charge	V <sub>CE</sub> = 480 V, I <sub>C</sub> = 40 A, V <sub>GE</sub> = 15 V	Q <sub>ge</sub>	_	41	-	
Gate to collector charge	1	Q <sub>gc</sub>	_	87	-	
SWITCHING CHARACTERISTIC, INDUC	TIVE LOAD			•		
Turn-on delay time		t <sub>d(on)</sub>	-	84	-	ns
Rise time	1	t <sub>r</sub>	_	40	-	
Turn-off delay time	T <sub>J</sub> = 25°C	t <sub>d(off)</sub>	_	177	-	
Fall time	$V_{CC} = 400 \text{ V}, I_{C} = 40 \text{ A}$ $R_{q} = 10 \Omega$	t <sub>f</sub>	_	70	-	
Turn-on switching loss	$V_{GE} = 0 \text{ V} / 15 \text{ V}$	E <sub>on</sub>	-	0.97	-	mJ
Turn-off switching loss	1	E <sub>off</sub>	_	0.44	-	
Total switching loss	1	E <sub>ts</sub>	_	1.41	-	
Turn-on delay time		t <sub>d(on)</sub>	_	82	-	ns
Rise time	1	t <sub>r</sub>	_	40	-	
Turn-off delay time	T <sub>J</sub> = 150°C	t <sub>d(off)</sub>	_	183	-	
Fall time	$V_{CC} = 400 \text{ V}, I_{C} = 40 \text{ A}$ $R_{g} = 10 \Omega$	t <sub>f</sub>	_	93	-	
Turn-on switching loss	V <sub>GE</sub> = 0 V/ 15 V	E <sub>on</sub>	_	1.20	-	mJ
Turn-off switching loss	1	E <sub>off</sub>	-	0.76	-	
Total switching loss	1	E <sub>ts</sub>	-	1.96	-	
DIODE CHARACTERISTIC				•		•
Forward voltage	V <sub>GE</sub> = 0 V, I <sub>F</sub> = 40 A V <sub>GE</sub> = 0 V, I <sub>F</sub> = 40 A, T <sub>J</sub> = 175°C	V <sub>F</sub>	1.50 -	2.20 2.40	2.90 -	V
Reverse recovery time	T <sub>.1</sub> = 25°C	t <sub>rr</sub>	_	72	-	ns
Reverse recovery charge	$I_F = 40 \text{ Å}, V_R = 200 \text{ V}$	Q <sub>rr</sub>	_	275	-	nC
Reverse recovery current	di <sub>F</sub> /dt = 200 A/μs	I <sub>rrm</sub>	_	6.7	-	Α
Reverse recovery time	T <sub>1</sub> = 175°C	t <sub>rr</sub>	_	158	-	ns
Reverse recovery charge	$I_F = 40^{\circ} A$ , $V_R = 400 \text{ V}$	Q <sub>rr</sub>	_	980	-	nC
Reverse recovery current	di <sub>F</sub> /dt = 200 A/μs	I <sub>rrm</sub>	_	8.5	_	Α

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.



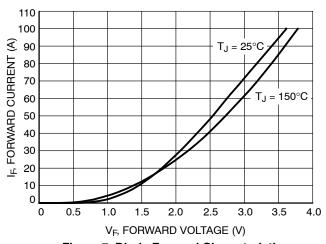


Figure 7. Diode Forward Characteristics

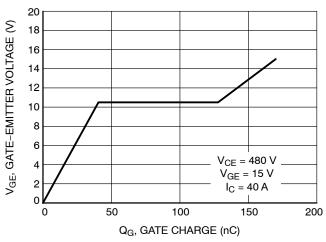


Figure 8. Typical Gate Charge

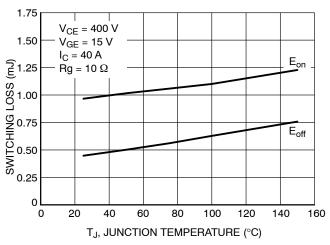


Figure 9. Switching Loss vs. Temperature

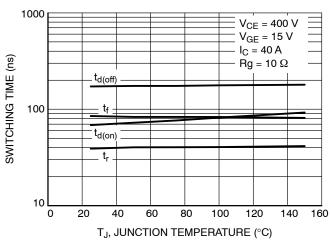


Figure 10. Switching Time vs. Temperature

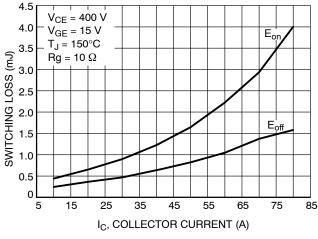


Figure 11. Switching Loss vs. I<sub>C</sub>

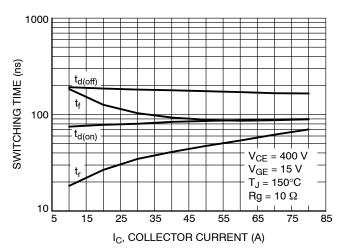


Figure 12. Switching Time vs. I<sub>C</sub>

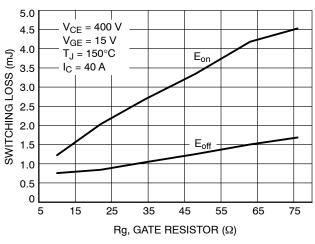


Figure 13. Switching Loss vs. Rg

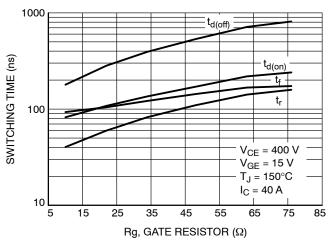


Figure 14. Switching Time vs. Rg

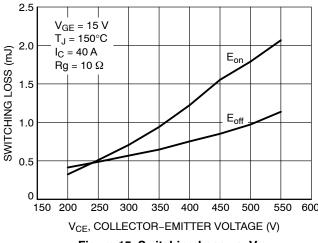


Figure 15. Switching Loss vs. V<sub>CE</sub>

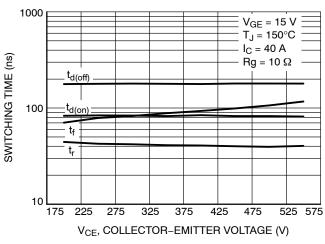


Figure 16. Switching Time vs. V<sub>CE</sub>

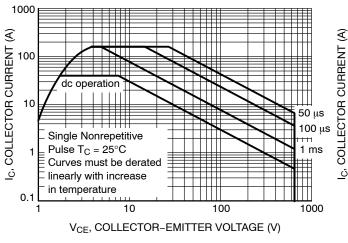


Figure 17. Safe Operating Area

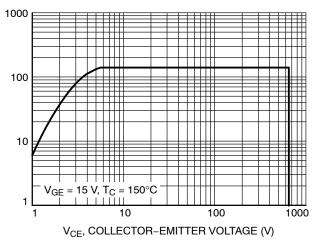
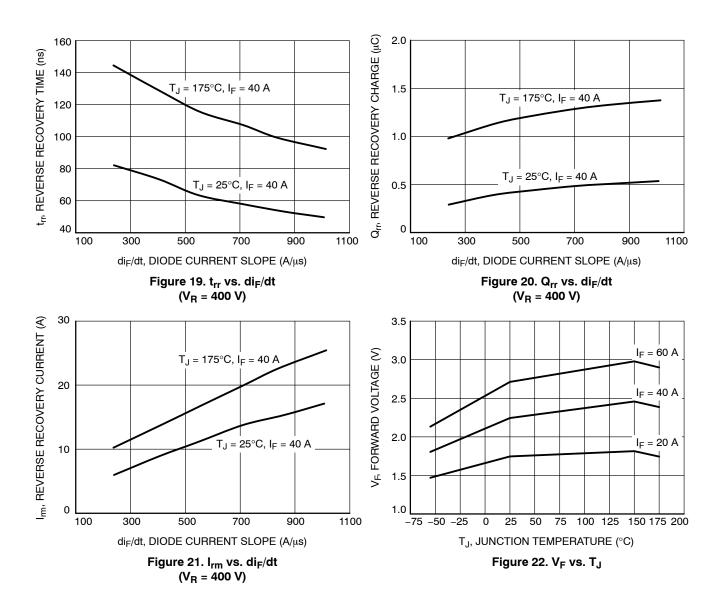


Figure 18. Reverse Bias Safe Operating Area



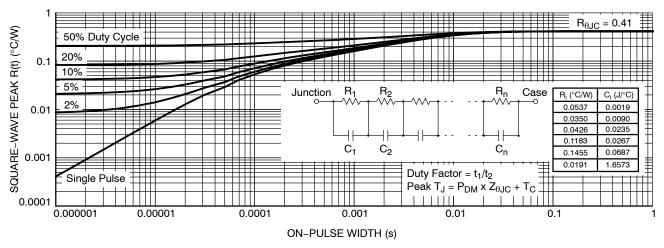


Figure 23. IGBT Transient Thermal Impedance

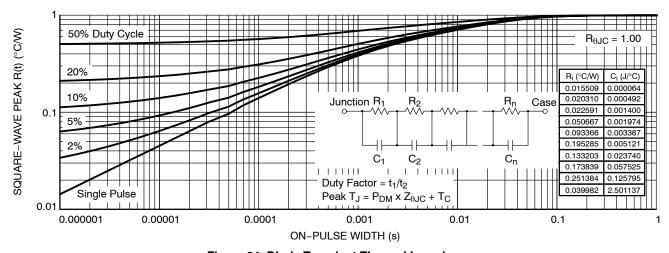


Figure 24. Diode Transient Thermal Impedance

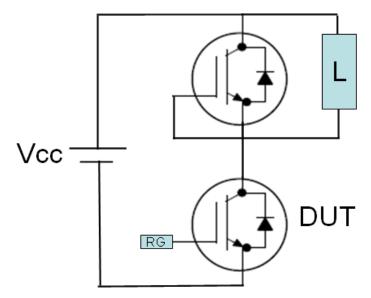


Figure 25. Test Circuit for Switching Characteristics

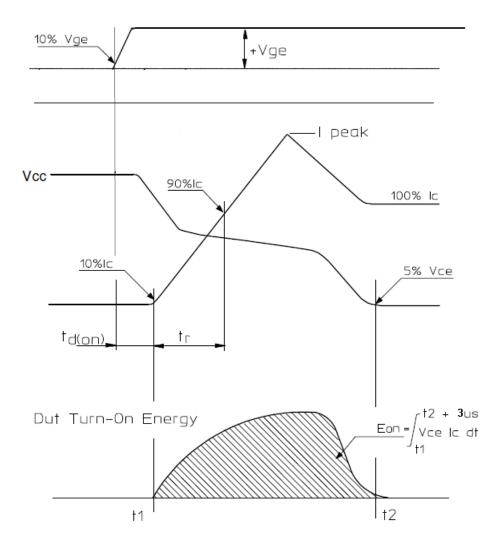


Figure 26. Definition of Turn On Waveform

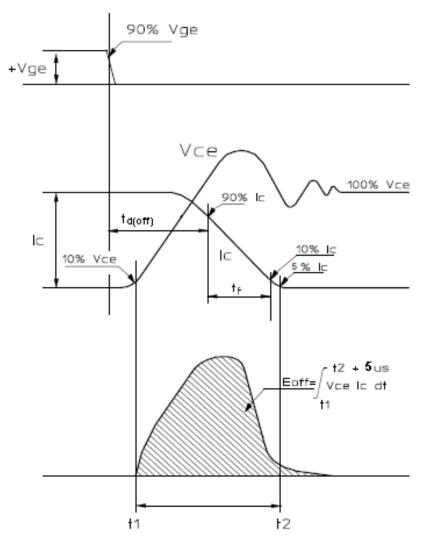
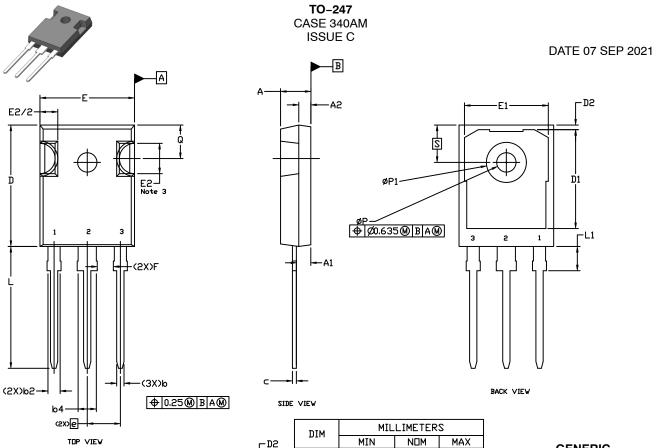
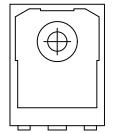


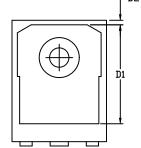
Figure 27. Definition of Turn Off Waveform



Α

4.70





NOTE 4 HEATSINK SHAPES

#### NOTES:

- 1. DIMENSIONING AND TOLERANCE AS PER ASME Y14.5M, 2009.
- 2. ALL DIMENSION ARE IN MILLIMETERS.
- SLOT REQUIRED, NOTCH MAY BE ROUNDED. 3.
- OPTIONAL BACK SIDE HEATSINK SHAPE.
- DIMENSIONS ARE EXCLUSIVE OF BURRS AND MOLD FLASH.
  DIMENSIONS D AND E ARE MEASURED AT THE OUTERMOST EXTREME OF THE PLASTIC BODY.
- 6. DIMENSIONS AT TO BE MEASURED IN THE REGION DEFINED BY L1.
- 7. LEAD FINISH IS UNCONTROLLED IN THE REGION DEFINED BY L1.

#### A1 2.20 2.40 2.60 Α2 1.80 2.00 2.20 1.20 1.07 1.33 b b2 1.65 2.12 2.35 b4 2.60 3.12 3.40 0.60 0.75 0.45 D 20.80 21.00 21.34 D1 16.30 ---D2 0.75 Ε 15.50 16.00 16.25 E1 13.80 F2 4 32 4 qn 5 4 9

5.00

5.30

LC	4.5	4.70	J.47
е	5.45 BSC		
F	2.655		
L	19.80	20.00	20.80
L1	3.81	4.20	4.35
Р	3.55	3.60	3.65
P1	6.60		
Q	5.40	6.00	6.20
2	6.15 BSC		

#### **GENERIC MARKING DIAGRAMS\***





XXXX = Specific Device Code = Assembly Location

Υ = Year WW = Work Week G = Pb-Free Package

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "■", may or may not be present. Some products may not follow the Generic Marking.

DOCUMENT NUMBER:	98AON77284F	Electronic versions are uncontrolled except when accessed directly from the Document Reposite Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.	
DESCRIPTION:	TO-247		PAGE 1 OF 1

ON Semiconductor and un are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. ON Semiconductor does not convey any license under its patent rights nor the rights of others.

onsemi, ONSEMI, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at <a href="www.onsemi.com/site/pdf/Patent-Marking.pdf">www.onsemi.com/site/pdf/Patent-Marking.pdf</a>. Onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using onsemi products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications provided by onsemi. "Typical" parameters which may be provided in onsemi data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. onsemi does not convey any license under any of its intellectual property rights nor the rights of others. onsemi products are not designed, intended, or authorized for use as a critical component in life support systems or any EDA class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer pu

#### **PUBLICATION ORDERING INFORMATION**

LITERATURE FULFILLMENT:
Email Requests to: orderlit@onsemi.com

onsemi Website: www.onsemi.com

TECHNICAL SUPPORT North American Technical Support: Voice Mail: 1 800-282-9855 Toll Free USA/Canada Phone: 011 421 33 790 2910

Europe, Middle East and Africa Technical Support:

a Phone: 00421 33 790 2910

For additional information, please contact your local Sales Representative

# **X-ON Electronics**

Largest Supplier of Electrical and Electronic Components

Click to view similar products for IGBT Transistors category:

Click to view products by ON Semiconductor manufacturer:

Other Similar products are found below:

 748152A
 APT20GT60BRDQ1G
 APT50GT60BRG
 NGTB10N60FG
 STGFW20V60DF
 APT30GP60BG
 APT45GR65B2DU30

 GT50JR22(STA1ES)
 TIG058E8-TL-H
 VS-CPV364M4KPBF
 NGTB25N120FL2WAG
 NGTG40N120FL2WG
 RJH60F3DPQ-A0#T0

 APT40GR120B2SCD10
 APT15GT120BRG
 APT20GT60BRG
 NGTB75N65FL2WAG
 NGTG15N120FL2WG
 IXA30RG1200DHGLB

 IXA40RG1200DHGLB
 APT70GR65B2DU40
 NTE3320
 IHFW40N65R5SXKSA1
 APT70GR120J
 APT35GP120JDQ2

 IKZA40N65RH5XKSA1
 IKFW75N65ES5XKSA1
 IKFW50N65ES5XKSA1
 IKFW50N65EH5XKSA1
 IKFW40N65ES5XKSA1

 IKFW60N65ES5XKSA1
 IMBG120R090M1HXTMA1
 IMBG120R220M1HXTMA1
 XD15H120CX1
 XD25H120CX0
 XP15PJS120CL1B1

 IGW30N60H3FKSA1
 STGWA8M120DF3
 IGW08T120FKSA1
 IGW75N60H3FKSA1
 HGTG40N60B3
 FGH60N60SMD\_F085

 FGH75T65UPD
 STGWA15H120F2
 IKA10N60TXKSA1
 IHW20N120R5XKSA1
 RJH60D2DPP-M0#T2
 IKP20N60TXKSA1

 IHW20N65R5XKSA1
 IDW40E65D2FKSA1